

Developed
technology

YU-FLEC

TFE (Thin Film Encapsulation) Technologies for OLEDs

We develop **TFE (Thin Film Encapsulation)** technologies for OLED devices, using organic resins developed by TOYO CHEM CO., LTD. (TOYO INK SC HOLDINGS group).

Technological features

Advantages of “Non-solvent UV-IJ resin ink” developed by TOYO CHEM

- To support SiNx barrier layer
- UV cure type (**non-solvent**)
- Applicable to **ink-jet**

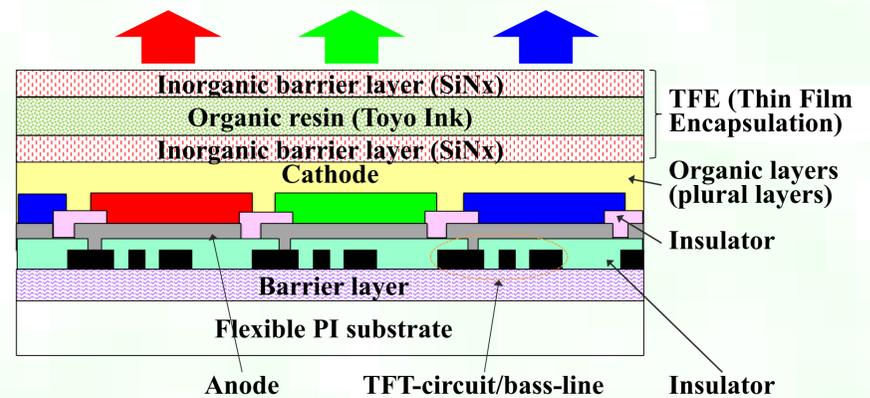


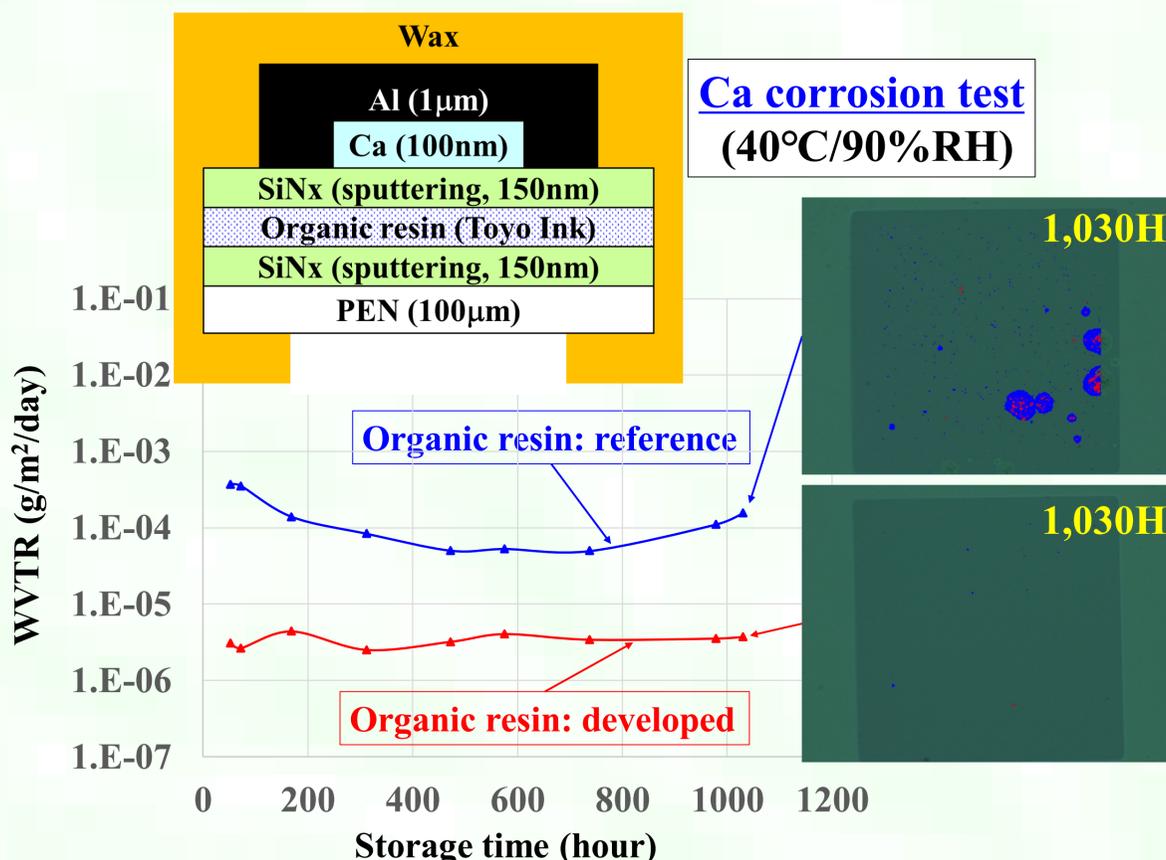
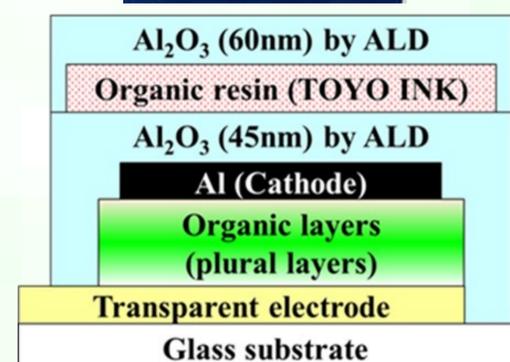
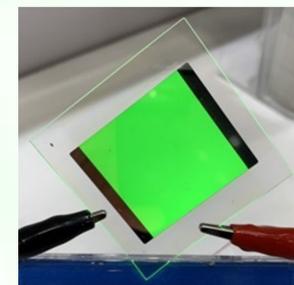
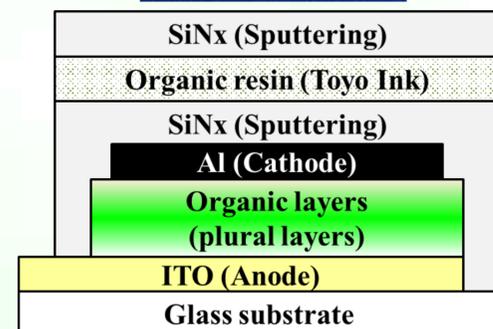
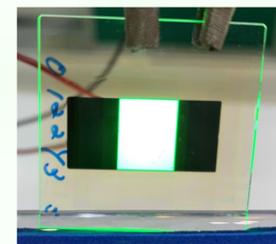
Image of OLED with TFE

Developed technologies

TFE structure with high gas barrier property

- TFE with “Non-solvent UV-IJ resin ink” developed by TOYO CHEM
- No actual damage after storage test of 1,000 hours under 40°C/90%RH
- WVTR (Water Vapor Transmission Rate): order of **10⁻⁶g/m²/day** (40°C/90%RH)

OLED device with the developed TFE structure



Collaboration **TOYO CHEM CO., LTD.**

Related program

- Yamagata University Flexible Electronics Consortium for Academia-Industry Cooperation (YU-FLEC) [Jan. 2018~Mar. 2023].
- MEXT: Construction Program of Open Innovation Organization [FY2018~FY2022].

Publication / Commercialization

- Yamagata University; “JFlex2020” (Jan. 2020 / Tokyo); “JFlex2019” (Jan. 2019 / Tokyo).
- The developed results have been applied to LIORESIT™ NSP 800 series (UV Curing/ IJ printing) of TOYO CHEM CO., LTD.